

2-input NOR Gate

REJ03D0183-0500Z (Previous ADE-205-310C (Z)) Rev.5.00 Jan.27.2004

Description

The HD74HC1G02 is high speed CMOS two input NOR gate using silicon gate CMOS process. With CMOS low power dissipation, it provides high-speed equivalent to LS–TTL series. The internal circuit of three stages construction with buffer provides wide noise margin and stable output.

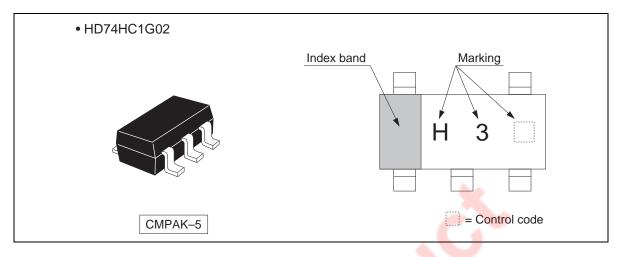
Features

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- Electrical characteristics equivalent to the HD74HC02 Supply voltage range : 2 to 6 V Operating temperature range : -40 to +85°C
- $|I_{OH}| = I_{OL} = 2 \text{ mA (min)}$
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC1G02CME	CMPAK-5 pin	CMPAK-5V	СМ	E (3,000 pcs/reel)



Outline and Article Indication



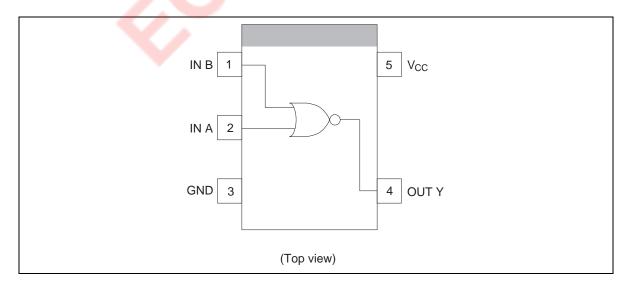
Function Table

Inputs		
Α	В	Output Y
L	L	Н
L	Н	
Н	L	L
Н	Н	L

H : High level

L : Low level

Pin Arrangement





Absolute Maximum Ratings

ltem	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{CC}	–0.5 to 7.0	V	
Input voltage range *1	VI	-0.5 to V _{CC} + 0.5	V	
Output voltage range *1, 2	Vo	–0.5 to V _{CC} + 0.5	V	Output : H or L
Input clamp current	I _{IK}	±20	mA	$V_I < 0 \text{ or } V_I > V_{CC}$
Output clamp current	Ι _{ΟK}	±20	mA	$V_0 < 0$ or $V_0 > V_{CC}$
Continuous output current	lo	±25	mA	$V_0 = 0$ to V_{CC}
Continuous current through V_{CC} or GND	I _{CC} or I _{GND}	±25	mA	h.
Maximum power dissipation at Ta = 25°C (in still air) *3	P _T	200	mW	~
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

Item	Symbol	Min	Мах	Unit	Test Conditions
Supply voltage range	Vcc	2	6	V	
Input voltage range	VI	0	V _{cc}	V	
Output voltage range	Vo	0	V _{cc}	V	
Output current	IOL	—	2.0	mA	$V_{CC} = 4.5 V$
		—	2.6		$V_{CC} = 6.0 V$
	I _{OH}	—	-2.0	mA	$V_{CC} = 4.5 V$
		—	-2.6		$V_{CC} = 6.0 V$
Input rise / fall time	t _r , t _f	0	1000	ns	$V_{CC} = 2.0 V$
(10% to 90%)		0	500		$V_{CC} = 4.5 V$
		0	400		$V_{CC} = 6.0 V$
Operating temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.



Electrical Characteristics

		Vcc	T _a = 2	5°C		T _a = -40 to 85°C					
Item	Symbol	(V)	Min	Тур	Max	Min	Max	Unit	Test Conditions		
Input voltage	V _{IH}	2.0	1.5	_	_	1.5		V			
		4.5	3.15	—	—	3.15	—	-			
		6.0	4.2	—	—	4.2	—	-			
	VIL	2.0	—	—	0.5	—	0.5	-			
		4.5	—	—	1.35	_	1.35	-			
		6.0	_	—	1.8	_	1.8	-			
Output voltage	V _{OH}	2.0	1.9	2.0	_	1.9	_	V	V _{IN} =	$I_{OH} = -20 \ \mu A$	
		4.5	4.4	4.5	_	4.4	_	-	V _{IH} or V _{IL}		
		6.0	5.9	6.0	—	5.9	_	6			
		4.5	4.18	4.31	_	4.13				$I_{OH} = -2 \text{ mA}$	
		6.0	5.68	5.80	—	5.63	-			$I_{OH} = -2.6 \text{ mA}$	
	V _{OL}	2.0	—	0.0	0.1	-	0.1			$I_{OL} = 20 \ \mu A$	
		4.5	_	0.0	0.1	- (0.1	-			
		6.0	_	0.0	0.1		0.1	-			
		4.5	_	0.17	0.26		0.33	-		$I_{OL} = 2 \text{ mA}$	
		6.0	—	0.18	0.26		0.33	-		I _{OL} = 2.6 mA	
Input current	I _{IN}	6.0	- <	-	±0.1	_	±1.0	μΑ	$V_{IN} = V_{CC} \text{ or } GND$		
Operating current	I _{CC}	6.0			1.0		10.0	μΑ	$V_{\text{IN}} = V_{\text{CC}}$	or GND	

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Switching Characteristics

		Ta = 25	°C				
Item	Symbol	Min	Тур	Тур Мах		Test Conditions	
Output rise / fall time	t _{TLH} t _{THL}	_	5	10	ns	Test circuit	
Propagation delay time	t _{PLH} t _{PHL}	—	7	15	ns	Test circuit	

 $(C_L = 15 \text{ pF}, t_r = t_f = 6 \text{ ns}, V_{CC} = 5 \text{ V})$

		Vcc	Ta = 25°C		Ta = -4	0 to 85°C			
ltem	Symbol	(V)	Min	Тур	Мах	Min	Max	Unit	Test Conditions
Output rise / fall time	t _{TLH}	2.0	_	50	125	_	155	ns	Test circuit
	t_{THL}	4.5	—	14	25	—	31		
		6.0	_	12	21	_	26		
Propagation delay time	t _{PLH}	2.0		48	100	-	125	ns	Test circuit
	t _{PHL}	4.5		12	20		25	_	
		6.0		9	17		21	_	
Input capacitance	C _{IN}	—		2.5	5	-	5	pF	
Equivalent capacitance	CPD	—	_	10	-		_	pF	

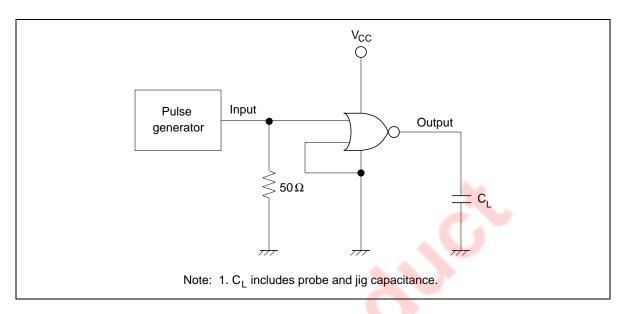
 $(C_L = 50 \text{ pF}, t_r = t_f = 6 \text{ ns})$

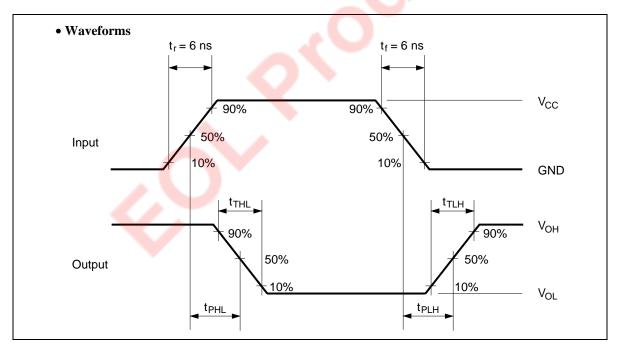
Note: C_{PD} is equivalent capacitance inside of the IC calculated from the operating current without load (see test circuit). The average operating current without load is calculated according to the expression below.

 I_{CC} (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$



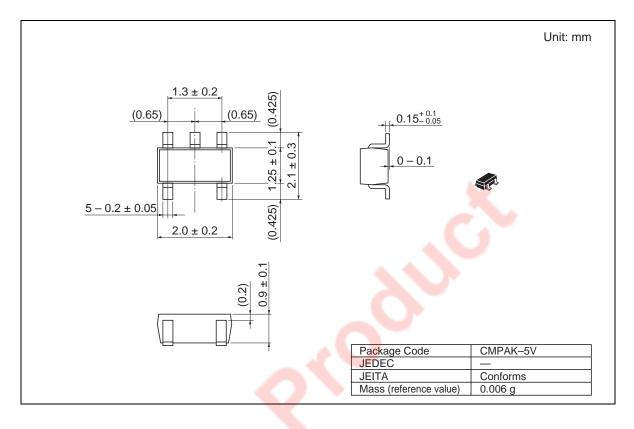
Test Circuit







Package Dimensions





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